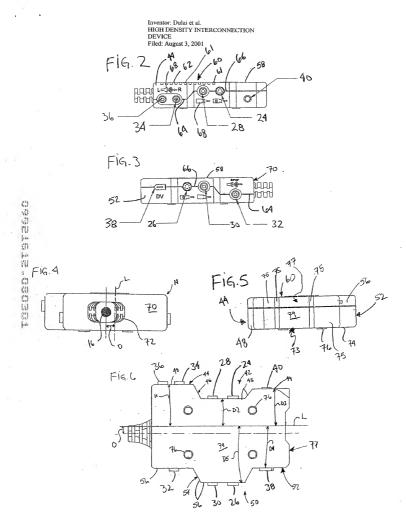


Figure 1



Inventor: Dulai et al.
HIGH DENSITY INTERCONNECTION
DEVICE
Filed: August 3, 2001

